

Chip Beads(SMD Array) For General Signal Line

Conformity to RoHS Directive

MZA Series MZA1608 Type

FEATURES

- A single MZA series chip provides noise attenuation for four lines, making it ideal for use with I/O lines of various highly miniaturized.
- Electronic equipment, such as portable products, which comprise high density circuitry.
- Low crosstalk between adjacent circuits.
- Internal electrodes feature low DC resistance, minimizing wasteful power consumption.
- Electroplated terminal electrodes accommodate reflow soldering.
- Monolithic structure ensures high reliability.
- It is a product conforming to RoHS directive.

APPLICATIONS

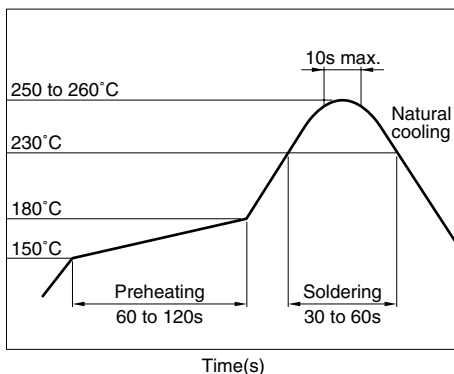
High-frequency noise countermeasure in computers, printers, VCRs, televisions, portable telephones, and other equipment.

PRODUCT IDENTIFICATION

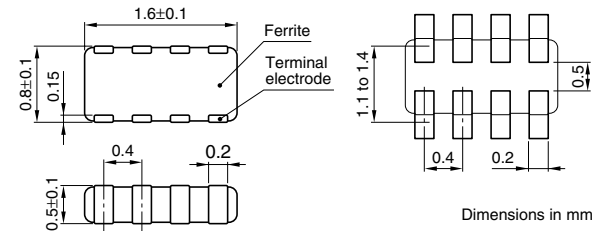
MZA 1608 S 121 C T
(1) (2) (3) (4) (5) (6)

- (1) Series name
- (2) Dimensions L×W
- (3) Material code
- (4) Nominal impedance
121:120Ω at 100MHz
- (5) Characteristic type
- (6) Packaging style
T:Taping

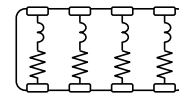
RECOMMENDED SOLDERING CONDITION REFLOW SOLDERING



SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN



CIRCUIT DIAGRAM



- No polarity



TEMPERATURE RANGES

Operating/storage	-55 to +125°C
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PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	5000 pieces/reel

HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- The inductance value may change due to magnetic saturation if the current exceeds the rated maximum.
- Do not expose the inductors to stray magnetic fields.
- Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.
- This product does not apply to flow soldering construction method.

• Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.

• Please contact our Sales office when your application are considered the following:
The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

• All specifications are subject to change without notice.

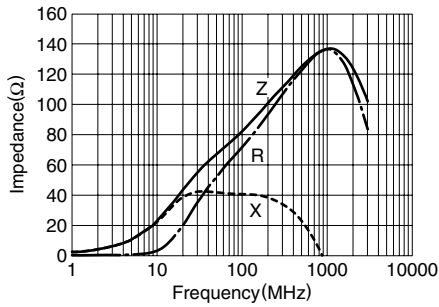
ELECTRICAL CHARACTERISTICS

Part No.	Impedance (Ω)[100MHz]*	DC resistance (Ω)max.	Rated current (mA)max.
MZA1608S800C	80 \pm 25%	0.35	150
MZA1608S121C	120 \pm 25%	0.4	150
MZA1608S241C	240 \pm 25%	0.5	150

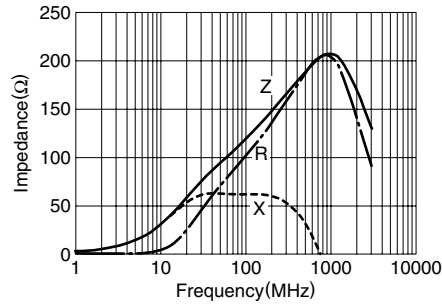
* Test equipment: E4991A or equivalent
 Test tool: 16192A or equivalent
 Test temperature: 25 \pm 10°C

TYPICAL ELECTRICAL CHARACTERISTICS Z, X, R vs. FREQUENCY CHARACTERISTICS

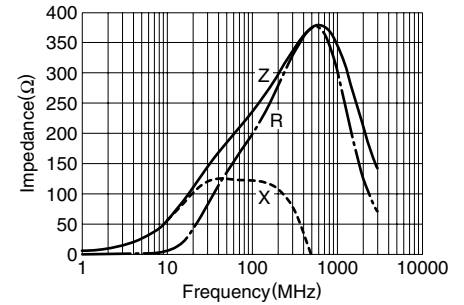
MZA1608S800C



MZA1608S121C

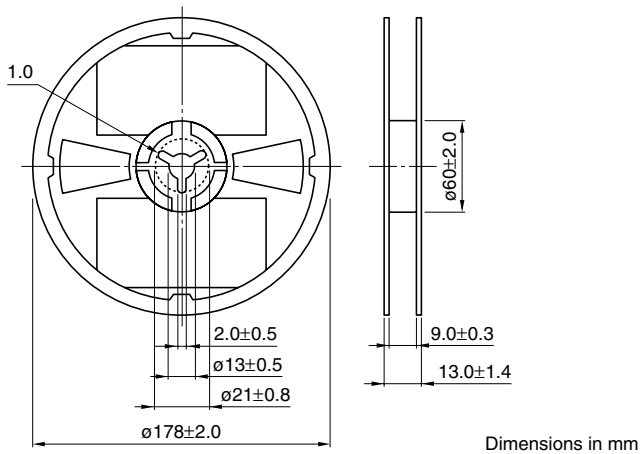


MZA1608S241C



PACKAGING STYLES

REEL DIMENSIONS



TAPE DIMENSIONS

